



FOCUS TECH PROCESS CHEMICALS

Technical Data Sheet

μETCH EC-2000 **Microetch Controller**



Description

The μ ETCH EC-2000 provides accurate, reliable control for all copper microetching processes. The μ ETCH EC-2000 controls total copper removal by replenishing fresh microetch solution based on copper concentration. The μ ETCH EC-2000 allows the manufacturer to maximize copper loading and minimize operating costs.

Features	Benefits
Steady state process	Increases uptime and improves process capability
In-tank or flow-through sensor options	Optimize performance based on immersion or conveyORIZED application
High quality process instrumentation	Accurate, reliable process control
Optional degasser	Improves control of peroxide/sulfuric microetches